

PATENT / DOCKET NO.: 24061.143 /TSMC2003-0876 CUSTOMER NO. 27683

INVENTOR'S DECLARATION FOR PATENT APPLICATION

As below named inventors, we hereby declare that:

Our residence, post office address and citizenship are as stated below next to our names;

We believe we are the original, first and sole joint inventors of the subject matter which is claimed and for which a patent is sought on the invention entitled

MULTIPLE WIDTH AND THICKNESS WRITE LINE IN MRAM

| the specification | n of which: (check one) |
|-------------------------------------|--|
| X | is attached hereto. |
| | was filed on |
| | under Attorney's Docket Number |
| | as Application Serial No. |
| | and was amended on (if applicable). |
| We hereby state including the cl | e that we have reviewed and understand the contents of the above identified specification, aims, as amended by any amendment referred to above. |
| accordance with became availab | ge the duty to disclose information which is material to the patentability of this application in a 37 CFR 1.56, including for continuation-in-part applications, material information which le between the filing date of the prior application and the national or PCT international filing inuation-in-part application. |
| made on inform knowledge that | are that all statements made herein of our own knowledge are true and that all statements nation and belief are believed to be true; and further that these statements were made with the willful false statements and the like so made are punishable by fine or imprisonment, or both, 1001 and that such willful false statements may jeopardize the validity of the application or ed thereon. |
| FULL NAME (| OF INVENTOR: Wen Chin Lin |
| INVENTOR'S | SIGNATURE: Worldin Com DATED: @fro/2004 |
| RESIDENCE: | 288, 4F-2 Park Road Hsin-Chu, Taiwan 300 Republic of China Citizenship: Taiwan, R.O.C. |

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FULL NAME OF INVENTOR:

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Citizenship: Taiwan, R.O.C.

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FULL NAME OF INVENTOR:

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INVENTOR'S SIGNATURE: _

DATED: 02/20 06

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IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re application of:

Lin et al.

Attorney Docket No.:

24061.143

TSMC2003-0876

Serial No.: Unknown

Customer No. 27683.

Group Art Unit: Unknown

Filed: Herewith

For:

MULTIPLE WIDTH AND

THICKNESS WRITE LINE IN MRAM

Examiner: n/a

Commissioner for Patents P. O. Box 1450 Alexandria, VA 22313-1450

POWER OF ATTORNEY FOR PATENT APPLICATION

As a representative of the Assignee, Taiwan Semiconductor Manufacturing, Co. Ltd., I hereby appoint the following attorneys and/or agents to prosecute this application and transact all business in the Patent and Trademark Office connected therewith.

David M. O'Dell (Reg. No. 42,044); David L. McCombs (Reg. No. 32,271); Jeffrey M. Becker (Reg. No. 35,442); James R. Bell (Reg. No. 26,528); Timothy F. Bliss (Reg. No. 50,925); Randall C. Brown (Reg. No. 31,213); Randall E. Colson (Reg. No. 40,566); Michael A. Davis, Jr. (Reg. No. 35,488); Ruben C. DeLeon (Reg. No. 37,812); Andrew S. Ehmke (Reg. No. 50,271); Rita M. Irani (Reg. No. 31,028); Warren B. Kice (Reg. No. 22,732); J. Andrew Lowes (Reg. No. 40,706); Todd Mattingly (Reg. No. 40,298); John Montgomery (Reg. No. 31,124); Bill R. Naifeh (Reg. No. 44,962); Gloria Norberg (Reg. No. 36,706); and Chien Wei Chou (Reg. No. 41,672).

Please address all correspondence and telephone calls regarding this application to:

David M. O'Dell Attorney for Applicants Haynes and Boone, LLP 901 Main Street, Suite 3100 Dallas, TX 75202-3789 972-739-8635

The undersigned is the representative for the Assignee of the entire right, title, and interest in the patent application identified above. A copy of the assignment or other documents in the chain of title are attached.

The undersigned (whose title is supplied below) is authorized to act on behalf of the Assignee.

March 3, 2004

Chien-Wei Chou

Title: Director, IP Division

Taiwan Semiconductor Manufacturing, Inc.

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ASSIGNMENT

WHEREAS, we

| (1) | Wen Chin Lin | of | 288, 4F-2, Park Road Hsin-Chu ,Taiwan 300 Republic of China |
|-----|------------------|----|--|
| (2) | Denny Tang | of | 20407 Cunningham Place Saratoga, CA 95070 |
| (3) | Li-Shyue Lai | of | 10F, No.5, Lane 371, Jhong Iheng E.Rd., Jhube City, Hsin Chu, Taiwan ROC |
| (4) | Chao-Hsiung Wang | of | 5F-1, No.29, JianZhong 1st Rd., Hsin-Chu, Taiwan 300 Republic of China |

have invented certain improvements in

MULTIPLE WIDTH AND THICKNESS WRITE LINE IN MRAM

for which we have executed an application for Letters Patent of the United States of America, of even date herewith; and

WHEREAS, Taiwan Semiconductor Manufacturing Company, Inc., ("TSMC"), No. 8, Li-Hsin Rd. 6, Science-Based Industrial Park Hsin-Chu, Taiwan 300-77, Republic of China. is desirous of obtaining the entire right, title, and interest in, to and under the said invention and the said application in the United States of America and in any and all countries foreign thereto;

NOW, THEREFORE, for One Dollar (\$1.00) and other good and valuable consideration, the receipt and sufficiency of which is hereby acknowledged, and other good and valuable consideration, we have sold, assigned, transferred and set over, and by these presents do hereby sell, assign, transfer and set over, unto the said TSMC, its successors, legal representatives, and assigns, the entire right, title, and interest in, to and under the said invention, and the said application, and all divisional, renewal, substitutional, and continuing applications thereof, and all Letters Patent of the United States of America which may be granted thereon and all reissues and extensions thereof, and all applications for Letters Patent which may be filed for said invention in any country or countries foreign to the United States of America, and all extensions, renewals, and reissues thereof, and all prior patents and patent applications from which a filing priority of the above-described patent application may be obtained, including the right to collect past damages; and we hereby authorize and request the Commissioner of Patents of the United States of America, and any official of any country or countries foreign to the United States of America, whose duty it is to issue patents on applications as aforesaid, to issue all Letters Patent for said invention to the said TSMC, its successors, legal representatives and assigns, in accordance with the terms of this instrument.

AND WE HEREBY covenant that we have full right to convey the entire interest herein assigned, and that we have not executed, and will not execute, any agreement in conflict herewith.

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AND WE HEREBY further covenant and agree that we will communicate to said TSMC, its successors, legal representatives and assigns, any facts known to us respecting said invention, and testify in any legal proceedings, sign all lawful papers, execute all divisional, renewal, substitutional, continuing, and reissue applications, make all rightful declarations and/or oaths and generally do everything possible to aid the said TSMC, its successors, legal representatives and assigns, to obtain and enforce proper patent protection for said invention in all countries.

| First Inventor Name: Residence Address: | Wen Chin Lin 288, 4F-2, Park Road Hsin-Chu, Taiwan 300 Republic of China |
|---|---|
| Dated: 02/20/2004 | Inventor Signature |
| Dated: \ \ \ \ \ \ \ \ \ \ \ \ \ \ \ \ | Ta-Wei Wang Witness Signature Witness Name: Ta-Wei Wang |
| Second Inventor Name: | Denny Tang 20407 Cunningham Place Saratoga, CA 95070 |
| Dated: . 2 / 20 / 20 9 4 | Inventor Signature |
| Dated: 0 > 20010 | Ta - Wei Wang Witness Signature Witness Name: <u>Ta - Wei Wang</u> |

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| Third Inventor Name: | Li-Shyue Lai |
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| Dated: | Inventor Signature |
| Dated: 07 (2000) | To-War Wang |
| | Witness Name: Ta-Wei Wang |
| Forth Inventor Name: | Chao-Hsiung Wang 5F-1, No.29, JianZhong 1st Rd., Hsin-Chu, Taiwan 300 Republic of China |
| Dated: 02/20/2014 | Inventor Signature |
| Dated: <u>ロン 20</u> 2014 | Ta-Wai Wang Witness Signature Witness Name: Ta-wei Wang |
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